

Pittsburgh, CA, USA - 24 May 2018

Name	Employer	Affiliation
Agnes, Andrea	STMicroelectronics	STMicroelectronics
Anslow, Peter	Ciena Corporation	Ciena Corporation
Beruto, Piergiorgio	Canovatech S.r.l.	Canova Tech Srl
bo, gao	Huawei Technologies Co. Ltd	Huawei Technologies Co., Ltd
Braun, Ralf-Peter	Deutsche Telekom AG	Deutsche Telekom AG
Brooks, Paul	Viavi solutions GmbH	Viavi Solutions
Brownlee, Phillip	TDK Corporation	TDK Corporation
Butter, Adrian	GLOBALFOUNDRIES	GLOBALFOUNDRIES
Carlson, Steven	High-Speed Design Inc.	Robert Bosch GmbH
Chabot, Craig	University of New Hampshire	University of New Hampshire
Chalupsky, David	Intel Corporation	Intel Corporation
Chang, Xin	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd
Choudhury, Golam	OFS	OFS
D'Ambrosia, John	Futurewei Technologies	Futurewei (Subsidiary of Huawei)
Dawe, Piers J G	Mellanox Technologies	Mellanox Technologies
Donahue, Curtis	University of New Hampshire	UNH-IOL
Dube, Kathryn	UNH-IOL	UNH-IOL
Dudek, Michael	Cavium	Cavium
Effenberger, Frank	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd
Gilb, James	General Atomics Aeronautical	GA-ASI, USD, Gilb Consulting
Graber, Steffen	Pepperl+Fuchs GmbH	Pepperl+Fuchs GmbH
Gustlin, Mark	Xilinx Inc	Xilinx
Hajduczenia, Marek	Charter Communications	Charter Communications
Healey, Adam	Broadcom Inc.	Broadcom Inc.
Heck, Howard	Intel Corporation	Intel Corporation
Hess, David	CORD DATA	CORD DATA
Holden, Brian	Kandou Bus	Kandou Bus
Horner, Rita	Synopsys, Inc.	Synopsys, Inc.
Huszak, Gergely	Self	Kone
Ingham, Jonathan	Foxconn Interconnect	Foxconn Interconnect
Johnson, John	Broadcom Limited	Broadcom Limited
Jones, Chad	Cisco Systems, Inc.	Cisco Systems, Inc.
Jones, Peter	Cisco Systems, Inc.	Cisco Systems, Inc.
Kareti, Upen	Cisco Systems, Inc.	Cisco Systems, Inc.
Kimber, Eric	Semtech Ltd	Semtech Ltd
Klempa, Michael	University of New Hampshire	University of New Hampshire
Kochuparambil, Elizabeth	Cisco Systems, Inc.	Cisco Systems, Inc.
Kolesar, Paul	CommScope	CommScope, Inc.
Laubach, Mark	Broadcom Limited	Broadcom Corporation
Law, David	Hewlett Packard Enterprise	Hewlett Packard Enterprise
Lawlis, James	Ford Motor Company	Ford Motor Company
Lewis, Jon	Dell EMC	Dell EMC
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Lusted, Kent	Intel Corporation	Intel Corporation
Maki, Jeffery	Juniper Networks, Inc.	Juniper Networks, Inc.
Malicoat, David	Malicoat Networking Solutions	Aquantia; SENKO Advanced
Marris, Arthur	Cadence Design Systems, Inc.	Cadence Design Systems, Inc.
Matoglu, Erdem	Amphenol Corporation	Amphenol Corporation
Ofelt, David	Juniper Networks, Inc.	Juniper Networks, Inc.
Pozzebon, Dino	Microsemi Corporation	Microsemi Corporation
Ran, Adee	Intel Corporation	Intel Corporation
Regev, Alon	Keysight Technologies	Keysight Technologies
Remein, Duane	Futurewei Technologies	Huawei Technologies Co. Ltd
Rotolo, Salvatore	STMicroelectronics	STMicroelectronics
Ryan, Tim	UNH-IOL	UNH-IOL
Rysin, Alexander	Mellanox Technologies	Mellanox Technologies
Sakai, Toshiaki	Socionext	socionext
Scantamburlo, Nicola	Canova Tech	Canova Tech
Shrikhande, Kapil	Innovium Inc.	Innovium
Slavick, Jeff	Broadcom Limited	Broadcom Limited
Smith, Daniel	Seagate Technology LLC	Seagate Technology LLC
Stassar, Peter	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd
Stewart, Heath	Analog Devices Inc.	Analog Devices Inc.
Thompson, Geoffrey	GraCaSI S.A.	INDEPENDENT
Trowbridge, Stephen	Nokia	Nokia
Vanderlaan, Paul	Berk-Tek LLC	Berk-Tek LLC
Wang, Xinyuan	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd
Willis, Paul	UNH-IOL	UNH-IOL
Withey, James	Fluke Corporation	Fluke Corporation
XU, LI	Huawei Technologies Co. Ltd	HUAWEI
Yamamoto, Shuto	Nippon Telegraph and Telephone	Nippon Telegraph and Telephone
Young, Adrian	Leviton Manufacturing Co.	Leviton Manufacturing Co.
Zerna, Conrad	Fraunhofer IIS	Fraunhofer IIS
Zimmerman, George	CME Consulting	ADI, APL Group, Aquantia, BMW,
Zivny, Pavel	Tektronix, Inc.	Tektronix, Inc.